

Title (en)  
MOUNTING ELECTRONIC COMPONENTS

Title (de)  
LAGERUNG VON ELEKTRONISCHEN BAUTEILEN

Title (fr)  
STOCKAGE DE COMPOSANTS ELECTRONIQUES

Publication  
**EP 2087769 A2 20090812 (DE)**

Application  
**EP 06804864 A 20061109**

Priority  
CH 2006000630 W 20061109

Abstract (en)  
[origin: WO2007038897A2] In order to mount, in a damped manner, electronic components inside an accommodating housing of an electronic small device, an elastic and/or flexible holding element (15) with inwardly projecting mounting areas (17) for mounting or holding the component (1) in position is placed along at least portions of the inside wall of the accommodating housing (3).

IPC 8 full level  
**H04R 25/00** (2006.01)

CPC (source: EP US)  
**H04R 25/456** (2013.01 - EP); **H04R 25/60** (2013.01 - EP US); **H04R 25/604** (2013.01 - EP US)

Citation (search report)  
See references of WO 2007038897A2

Cited by  
EP3614697A1; US10863292B2

Designated contracting state (EPC)  
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DOCDB simple family (publication)  
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